

## DECLARATION

As the below-named inventors, we declare that:

Our residences, post office addresses, and citizenships are as stated below under our names.

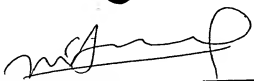
We believe we are the original, first, and joint inventors of the invention entitled "POLISHING PADS AND PLANARIZING MACHINES FOR MECHANICAL AND CHEMICAL-MECHANICAL PLANARIZATION OF MICROELECTRONIC-DEVICE SUBSTRATE ASSEMBLIES, AND METHODS FOR MAKING AND USING SUCH PADS AND MACHINES," which is described and claimed in the foregoing specification and for which a patent is sought.

We have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment specifically referred to herein (if any).


We acknowledge our duty to disclose information of which we are aware which is material to patentability and examination of this application in accordance with 37 C.F.R. § 1.56(a).

We further declare that all statements made herein of our own knowledge are true and that all statements made on information and belief are believed to be true; and further, that these statements were made with the knowledge that the making of willfully false statements and the like is punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and may jeopardize the validity of any patent issuing from this patent application.

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 Vishnu K. Agarwal

Date 12<sup>th</sup> November, 1998  
 Residence : City of Boise, County of Ada  
 State of Idaho  
 Citizenship : India  
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 Scott G. Meikle

Date 17<sup>th</sup> November, 1998  
 Residence : City of Boise, County of Ada  
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 Citizenship : Canada  
 P.O. Address : 1301 E. Jefferson  
 Boise, Idaho 83712

PATENT

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Vishnu K. Agarwal and Scott G. Meikle  
 Filed : Concurrently herewith  
 For : POLISHING PADS AND PLANARIZING MACHINES  
 FOR MECHANICAL OR CHEMICAL-MECHANICAL  
 PLANARIZATION OF MICROELECTRONIC-DEVICE  
 SUBSTRATE ASSEMBLIES, AND METHODS FOR  
 MAKING AND USING SUCH PADS AND MACHINES

Docket No. : 660073.703

Box Patent Application  
 Assistant Commissioner for Patents  
 Washington, DC 20231

ELECTION UNDER 37 C.F.R. §§ 3.71 AND 3.73 AND POWER OF ATTORNEY

Sir:

The undersigned, being Assignee of the entire interest in the above-identified application by virtue of an Assignment filed concurrently herewith, hereby elects, under 37 C.F.R. § 3.71, to prosecute the application to the exclusion of the inventors.

Assignee hereby appoints RICHARD W. SEED, Reg. No. 16,557; ROBERT J. BAYNHAM, Reg. No. 22,846; EDWARD W. BULCHIS, Reg. No. 26,847; GEORGE C. RONDEAU, JR., Reg. No. 28,893; DAVID H. DEITS, Reg. No. 28,066; WILLIAM O. FERRON, JR., Reg. No. 30,633; PAUL T. MEIKLEJOHN, Reg. No. 26,569; DAVID J. MAKI, Reg. No. 31,392; RICHARD G. SHARKEY, Reg. No. 32,629; DAVID V. CARLSON, Reg. No. 31,153; MAURICE J.

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Please direct all communications to:


Paul T. Parker, Esq.  
Seed and Berry LLP  
6300 Columbia Tower  
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Seattle, Washington 98104-7092

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Pursuant to 37 C.F.R. § 3.73, the undersigned duly authorized designee of Assignee certifies that the evidentiary documents have been reviewed, specifically the Assignment to MICRON TECHNOLOGY, INC., filed concurrently herewith for recording, a copy of which is attached hereto, and certifies that to the best of my knowledge and belief, title remains in the name of the Assignee.

MICRON TECHNOLOGY, INC.  
ASSIGNEE

Mar 23, 1998  
DATE

  
Michael L. Lynch  
Chief Patent Counsel

Enclosure:

Copy of Assignment

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PATENT

## ADDENDUM A

## THE UNITED STATES PATENT AND TRADEMARK OFFICE

Assistant Commissioner for Patents  
Washington, DC 20231

REVOCATION AND SUBSTITUTE POWER OF ATTORNEY

Sir:

In the matter of the patent applications identified in Exhibit A attached hereto, I, MICHAEL L. LYNCH, declare that I am a duly authorized designee of Micron Technology, Inc., the ASSIGNEE of the entire right, title and interest in and to the above-referenced patent applications. Documentary evidence of chain of title from the original owner to ASSIGNEE has been or is concurrently being filed with and recorded by the United States Patent Office. The evidentiary documents referred to in the instant Revocation and Power of Attorney have been reviewed by the undersigned, and it is certified that, to the best of ASSIGNEE's knowledge and belief, title is held solely in and by ASSIGNEE.

On behalf ASSIGNEE, I revoke all power of attorney heretofore given, and hereby appoint EDWARD W. BULCHIS, Reg. No. 26,847; JON F. TUTTLE, Reg. No. 25,713; PAUL T. MEIKLEJOHN, Reg. No. 26,569; GLENN P. RICKARDS, Reg. No. 29,428; DALE C. BARR, Reg. No. 40,498; KIMTON N. ENG, Reg. No. 43,605; DAVID E. BOONE, Reg. No. 27,857; SCOTT W. DOYLE, Reg. No. 39,176; REED R. HEIMBECHER, Reg. No. 36,353; JOHN T. KENNEDY, Reg. No. 42,717; GREGORY D. LEIBOLD, Reg. No. 36,408; GARY M. POLUMBUS, Reg. No. 25,364; THOMAS H. YOUNG, Reg. No. 25,796; W. ROBINSON H. CLARK, Reg. No. 41,530; GREGORY J. GLOVER, Reg. No. 34,173; JOHN K. HARROP, Reg. No. 41,817; CHRIS McWHINNEY, Reg. No. 42,875; ALDO NOTO, Reg. No. 35,628; MATTHEW PHILLIPS, Reg. No. 43,403; JOHN W. RYAN, Reg. No. 33,771; AMI P. SHAH,

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Please direct all future correspondence and telephone calls to:

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ASSIGNEE:  
Micron Technology, Inc.

Jan 3, 2000  
Date

By 

Michael L. Lynch  
Chief Patent Counsel

Exhibit A

<u>Appl. No.</u>	<u>Attr Dkt #</u>	<u>Applicants</u>	<u>Filed</u>	<u>Title</u>
09/201,576	660073.703	Vishnu K. Agarwal and Scott Melkie	30-Nov-98	Polishing Pads and Planarizing Machines, for Mechanical or Chemical-Mechanical Planarization of Microelectronic-Device Substrate Assemblies, and Methods for Making and Using Such Pads and Machines

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